

N-Channel PowerTrench[®] MOSFET 100 V, 45 A, 6 m Ω

Features

- Max $r_{DS(on)} = 6 \text{ m}\Omega$ at $V_{GS} = 10 \text{ V}$, $I_D = 14 \text{ A}$
- Max $r_{DS(on)}$ = 11 m Ω at V_{GS} = 6 V, I_D = 11.5 A
- Advanced Package and Silicon combination for low r_{DS(on)} and high efficiency
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

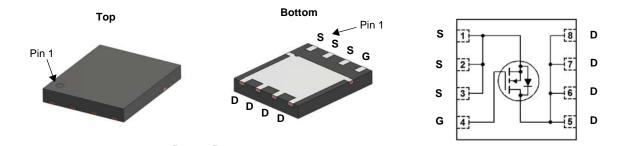


General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced Power Trench[®] process thant has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

Applications

- Primary DC-DC MOSFET
- Secondary Synchronous Rectifier
- Load Switch



Power 56

MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			100	V	
V _{GS}	Gate to Source Voltage			±20	V	
	Drain Current -Continuous	T _C = 25 °C		45		
I _D	-Continuous	T _A = 25 °C	(Note 1a)	14	Α	
	-Pulsed			260		
E _{AS}	Single Pulse Avalanche Energy (Note 3)		541	mJ		
P _D	Power Dissipation	T _C = 25 °C		125		
	Power Dissipation	T _A = 25 °C	(Note 1a)	2.7		
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +150	°C		

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	1.0	0 0 000
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note	la) 45	°C/W

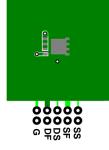
Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS86152	FDMS86152	Power 56	13 "	12 mm	3000 units

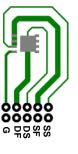
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
Off Chara	octeristics						
BV _{DSS}	Drain to Source Breakdown Voltage	$I_{D} = 250 \ \mu A, \ V_{GS} = 0 \ V$	100			V	
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °	C	90		mV/°C	
IDSS	Zero Gate Voltage Drain Current	V _{DS} = 80 V, V _{GS} = 0 V			1	μA	
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA	
On Chara	cteristics						
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	2	3	4	V	
$\frac{\Delta V_{GS(th)}}{\Delta T_{J}}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °	С	-10		mV/°C	
r _{DS(on)}		V _{GS} = 10 V, I _D = 14 A		5.2	6		
	Static Drain to Source On Resistance	V _{GS} = 6 V, I _D = 11.5 A		7.3	11	mΩ	
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 14 \text{ A}, \text{ T}_{J} = 125 \text{ M}$	°C	8.7	10		
9 _{FS}	Forward Transconductance	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 14 \text{ A}$		42		S	
Dynamic	Characteristics						
C _{iss}	Input Capacitance			2530	3370	pF	
C _{oss}	Output Capacitance	— V _{DS} = 50 V, V _{GS} = 0 V, — f = 1 MHz		595	795	pF	
C _{rss}	Reverse Transfer Capacitance			22	35	pF	
R _g	Gate Resistance			0.9		Ω	
Switching	Characteristics						
t _{d(on)}	Turn-On Delay Time			17	30	ns	
t _r	Rise Time	V _{DD} = 50 V, I _D = 14 A,		6	12	ns	
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		25	39	ns	
t _f	Fall Time			5	10	ns	
Q _g	Total Gate Charge	$V_{GS} = 0 V$ to 10 V		36	50	nC	
Q _q	Total Gate Charge	$V_{GS} = 0 V \text{ to } 6 V$ $V_{DD} = 50 V$		23	33	nC	
Q _{gs}	Gate to Source Charge	$I_{\rm D} = 14 \text{ A}$		10.7		nC	
Q _{gd}	Gate to Drain "Miller" Charge			7.2		nC	
-	urce Diode Characteristics		1				
		$V_{GS} = 0 V, I_S = 2.1 A$ (Note	e 2)	0.70	1.2		
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 14 A$ (Note	e 2)	0.78	1.3	V	
t _{rr}	Reverse Recovery Time		,	59	94	ns	
	-	— I _F = 14 A, di/dt = 100 A/μs		-		+	

Notes:

1. R_{0JA} is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0JC} is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design.



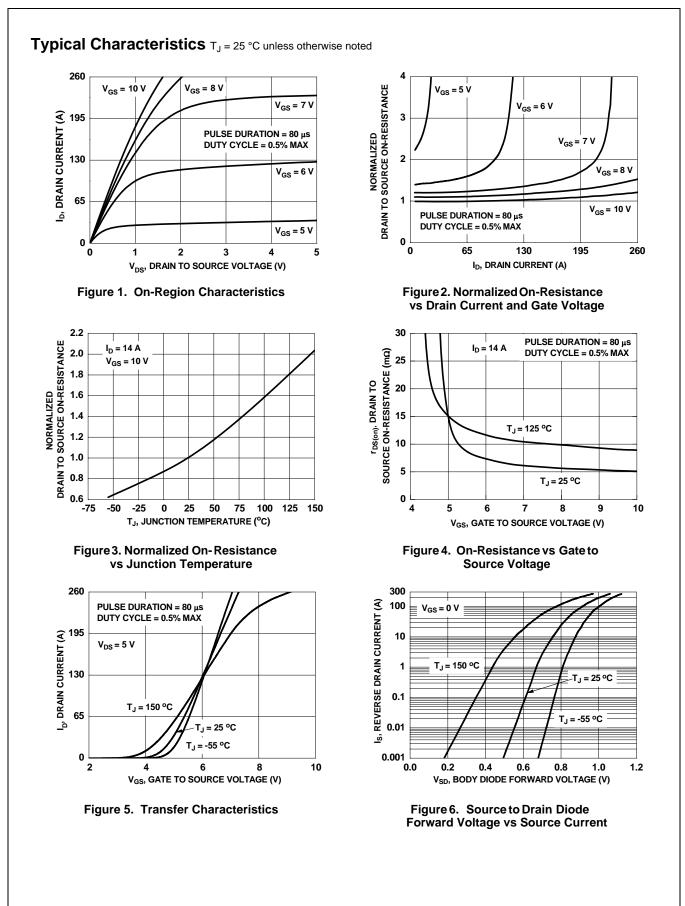
a. 45 °C/W when mounted on a 1 in² pad of 2 oz copper.



b. 115 °C/W when mounted on a minimum pad of 2 oz copper.

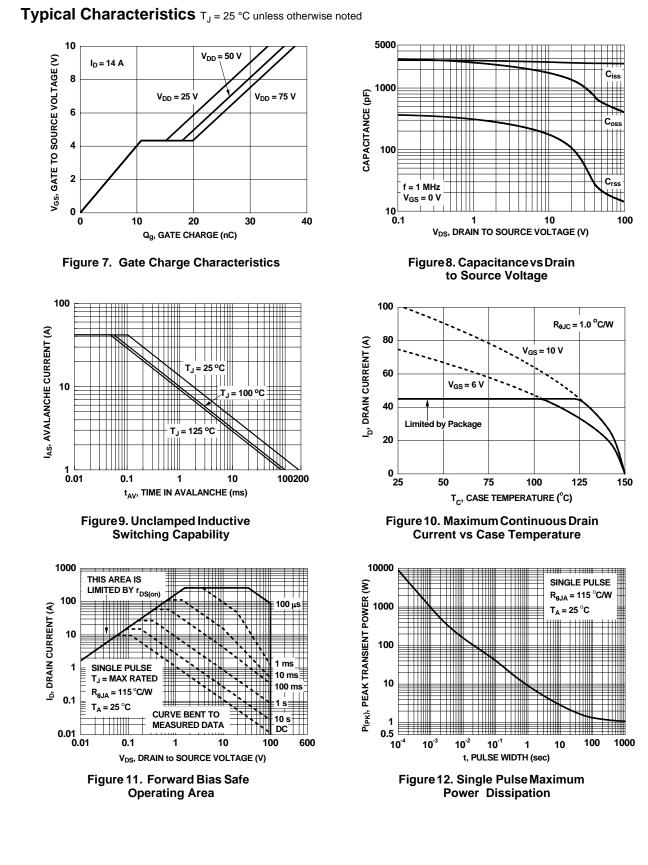
2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0%.

3. Starting T_J = 25 °C, L = 3 mH, I_{AS} = 19 A, V_{DD} = 100 V, V_{GS} = 10 V. 100% test at L = 0.3 mH, I_{AS} = 42 A.



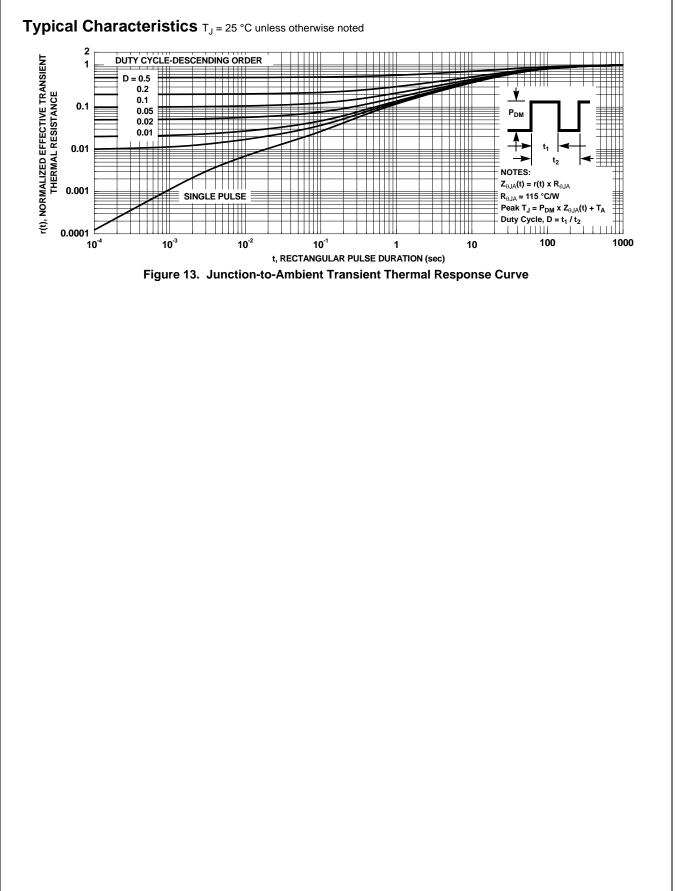
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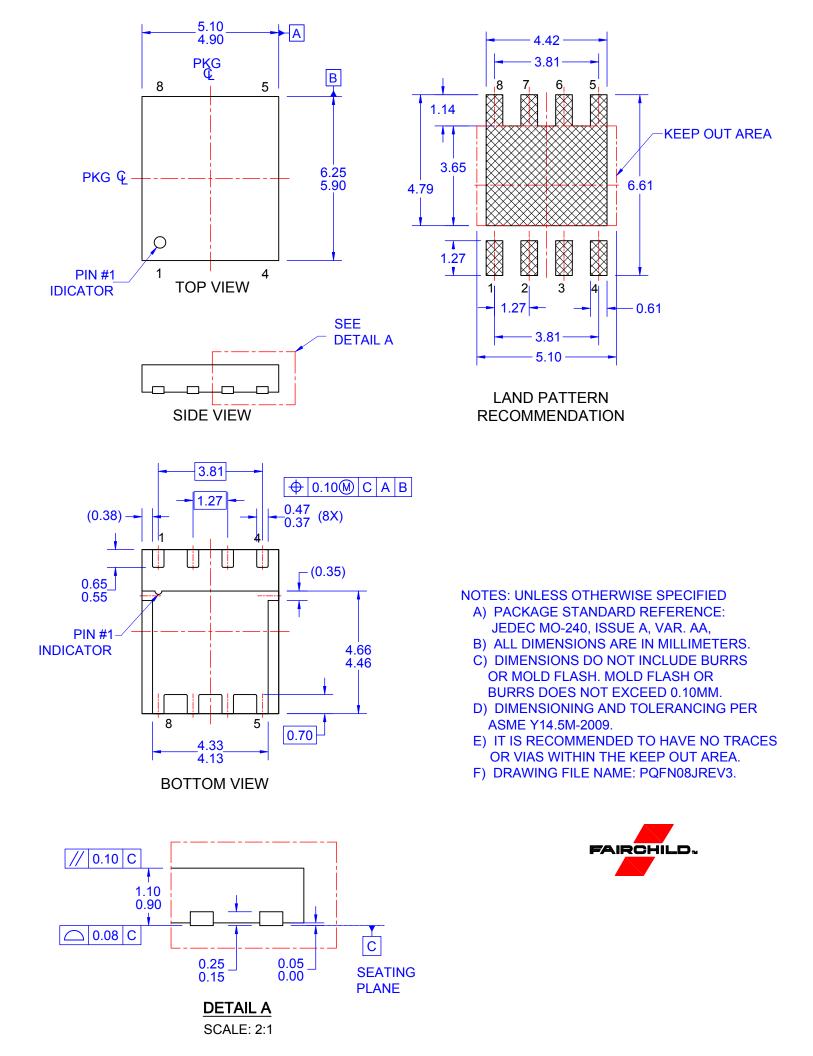


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FDMS86152 N-Channel PowerTrench[®] MOSFET





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Rev. 177